

### • General Description

The AGM3400EL combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

### • Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

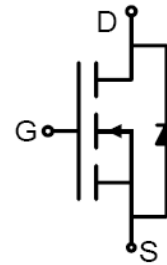
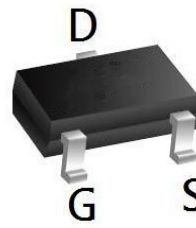
### • Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

### Product Summary

BVDSS	RDS(ON)	ID
30V	20mΩ	5.6A

### SOT-23 Pin Configuration



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
3400EL	AGM3400EL	SOT-23	----	----	3000

**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	30	V
VGS	Gate-Source Voltage (VDS=0V)	±12	V
ID	Drain Current-Continuous(TA=25°C) <b>(Note 1)</b>	5.6	A
	Drain Current-Continuous(TA=70°C)	4.5	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed <b>(Note 2)</b>	23	A
PD	Maximum Power Dissipation(TA=25°C)	1.2	w
	Maximum Power Dissipation(TA=70°C)	0.8	w
EAS	Avalanche energy <b>(Note 3)</b>	--	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>	---	104	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>	---	--	°C/W

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	30	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=30V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±12V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	0.65	0.9	1.5	V
gFS	Forward Transconductance	VDS=5V,ID=4.2A	--	--	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=5.6A	--	20	25	mΩ
		VGS=4.5V, ID=5.0A	--	23	31	mΩ
		VGS=2.5V, ID=3A	--	27	45	mΩ
<b>Dynamic Characteristics</b>						
Ciss	Input Capacitance	VDS=15V,VGS=0V, F=1MHZ	--	630	--	pF
Coss	Output Capacitance		--	55	--	pF
Crss	Reverse Transfer Capacitance		--	71	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	--	--	Ω
<b>Switching Times</b>						
td(on)	Turn-on Delay Time	VGS=10V,VDS=15V, RGEN=3Ω,ID=5.6A	--	4.4	--	nS
tr	Turn-on Rise Time		--	28	--	nS
td(off)	Turn-Off Delay Time		--	16	--	nS
tf	Turn-Off Fall Time		--	26	--	nS
Qg	Total Gate Charge	VGS=10V, VDS=15V, ID=5.6A	--	17	--	nC
Qgs	Gate-Source Charge		--	2.1	--	nC
Qgd	Gate-Drain Charge		--	2.0	--	nC
<b>Source-Drain Diode Characteristics</b>						
ISD	Source-Drain Current(Body Diode)		--	--	5.6	A
VSD	Forward on Voltage	VGS=0V,IS=5.6A	--	--	1.2	V
trr	Reverse Recovery Time	IF=5.6A , dl/dt=100A/μs , TJ=25°C	--	1.1	--	ns
Qrr	Reverse Recovery Charge		--	13.1	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25°C

### ■ Typical Performance Characteristics

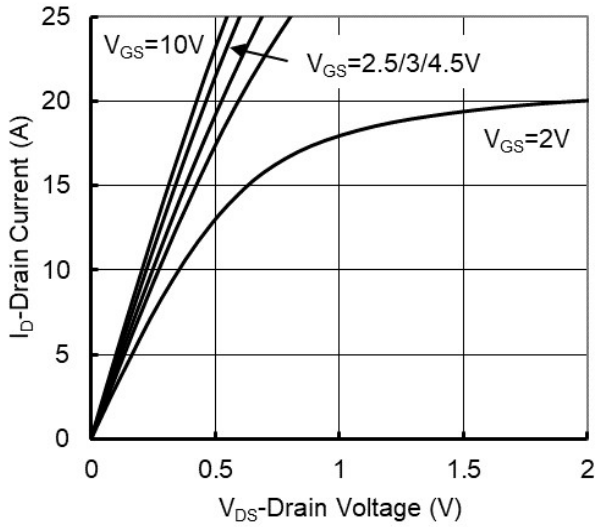


Figure1. Output Characteristics

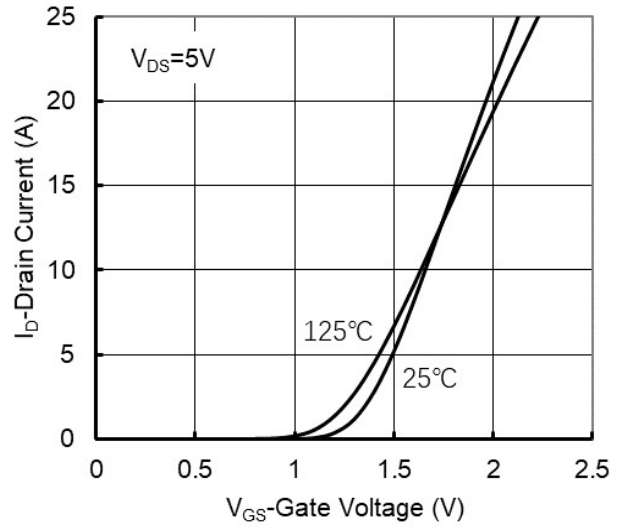


Figure2. Transfer Characteristics

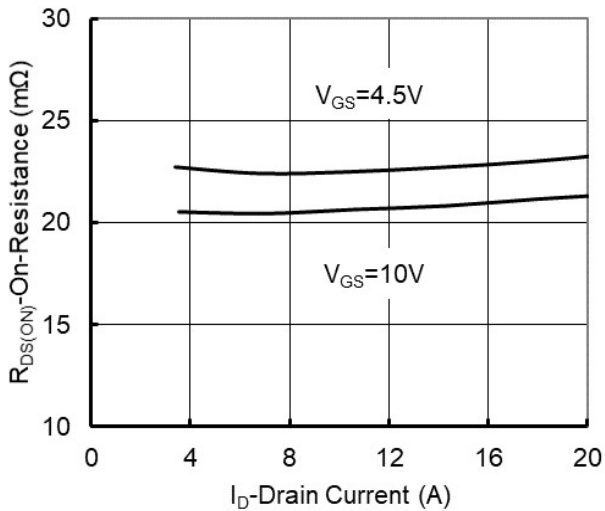


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

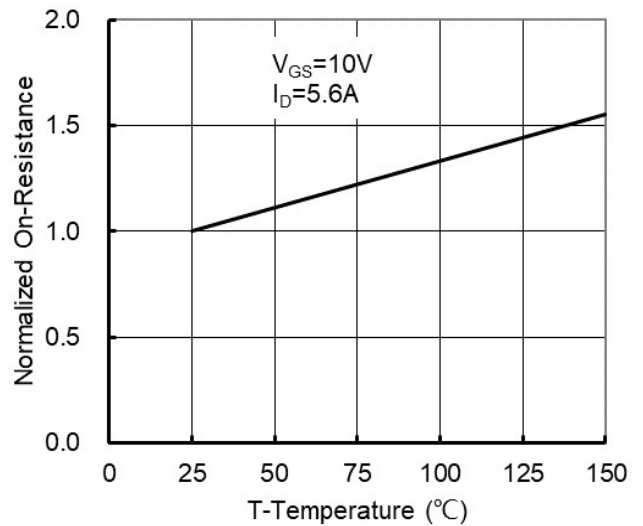


Figure 4: On-Resistance vs. Junction Temperature

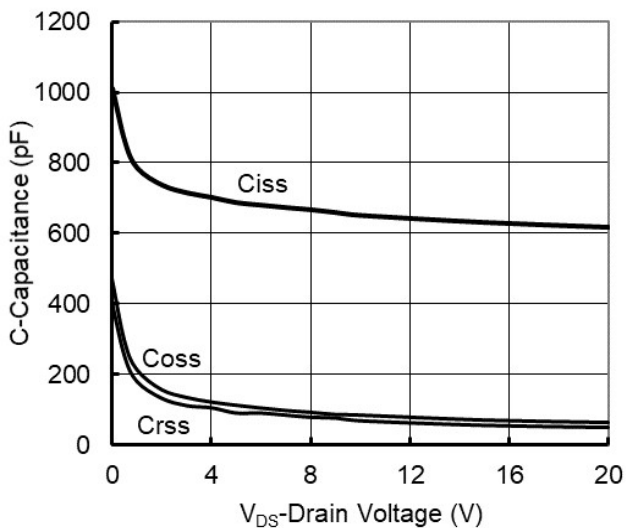


Figure5. Capacitance Characteristics

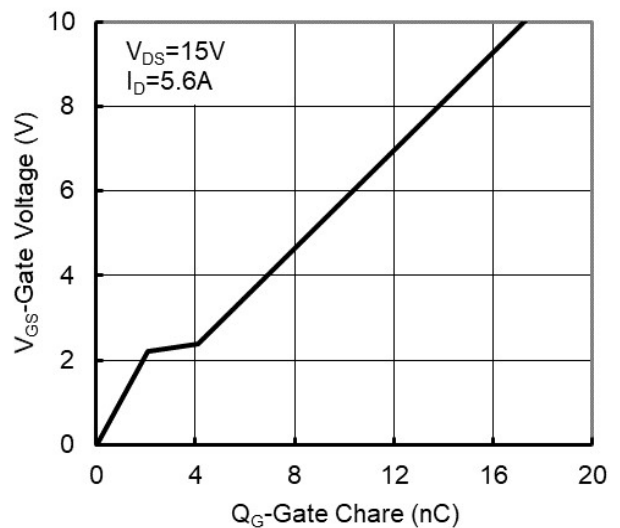


Figure6. Gate Charge

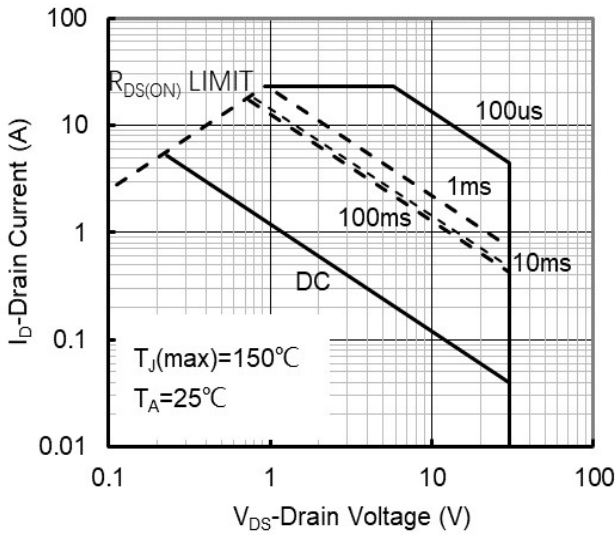


Figure7. Safe Operation Area

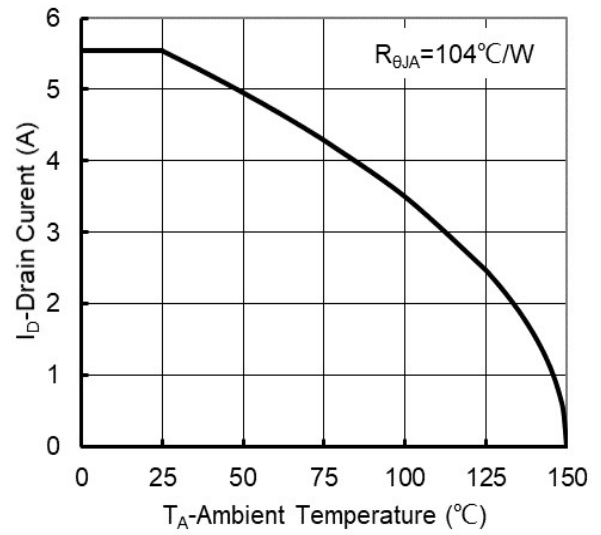


Figure8. Maximum Continuous Drain Current vs Ambient Temperature

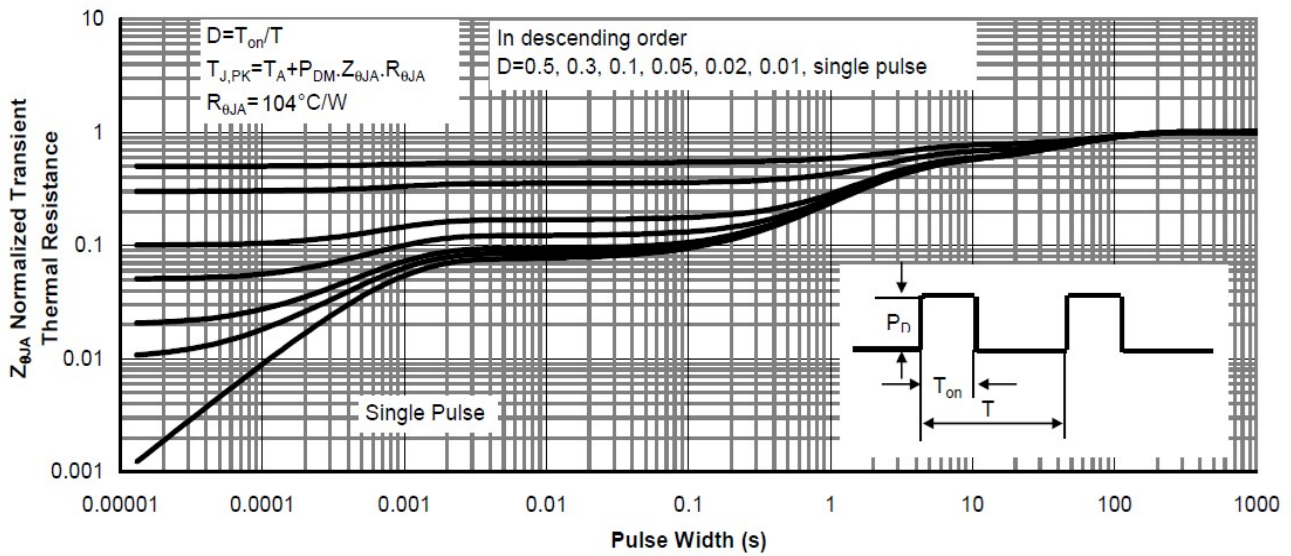
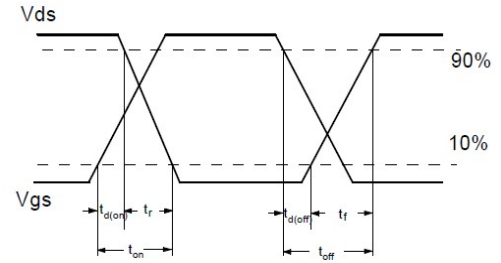
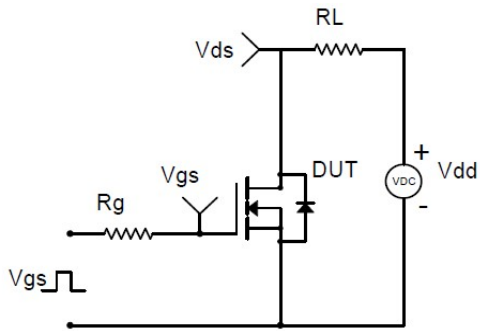
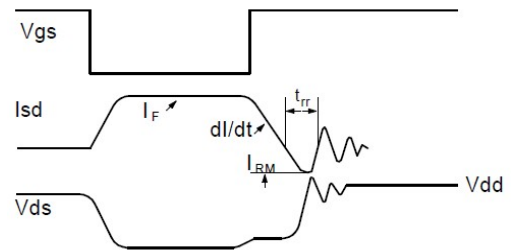
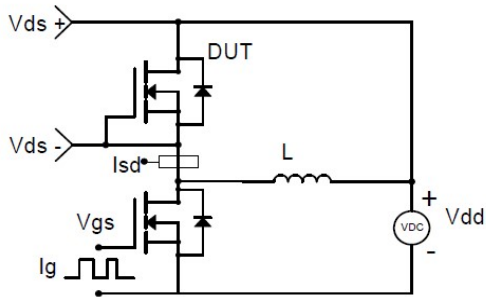
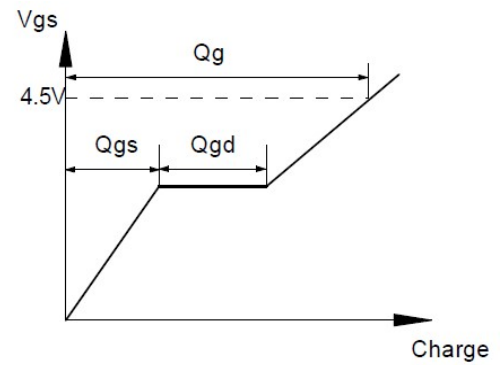
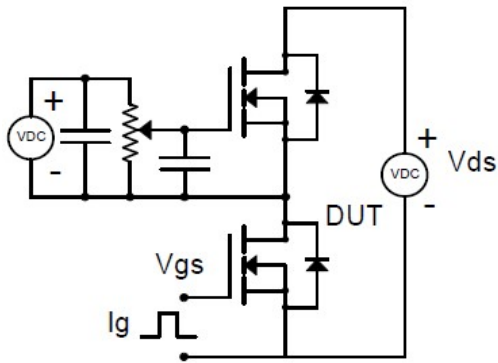
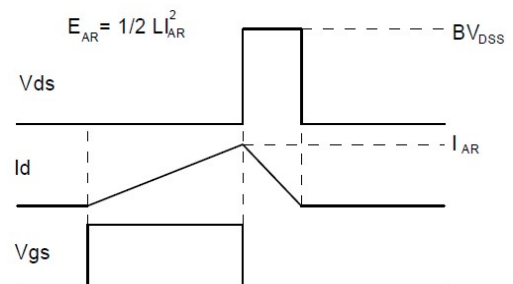
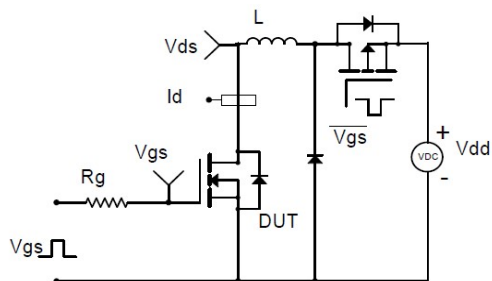
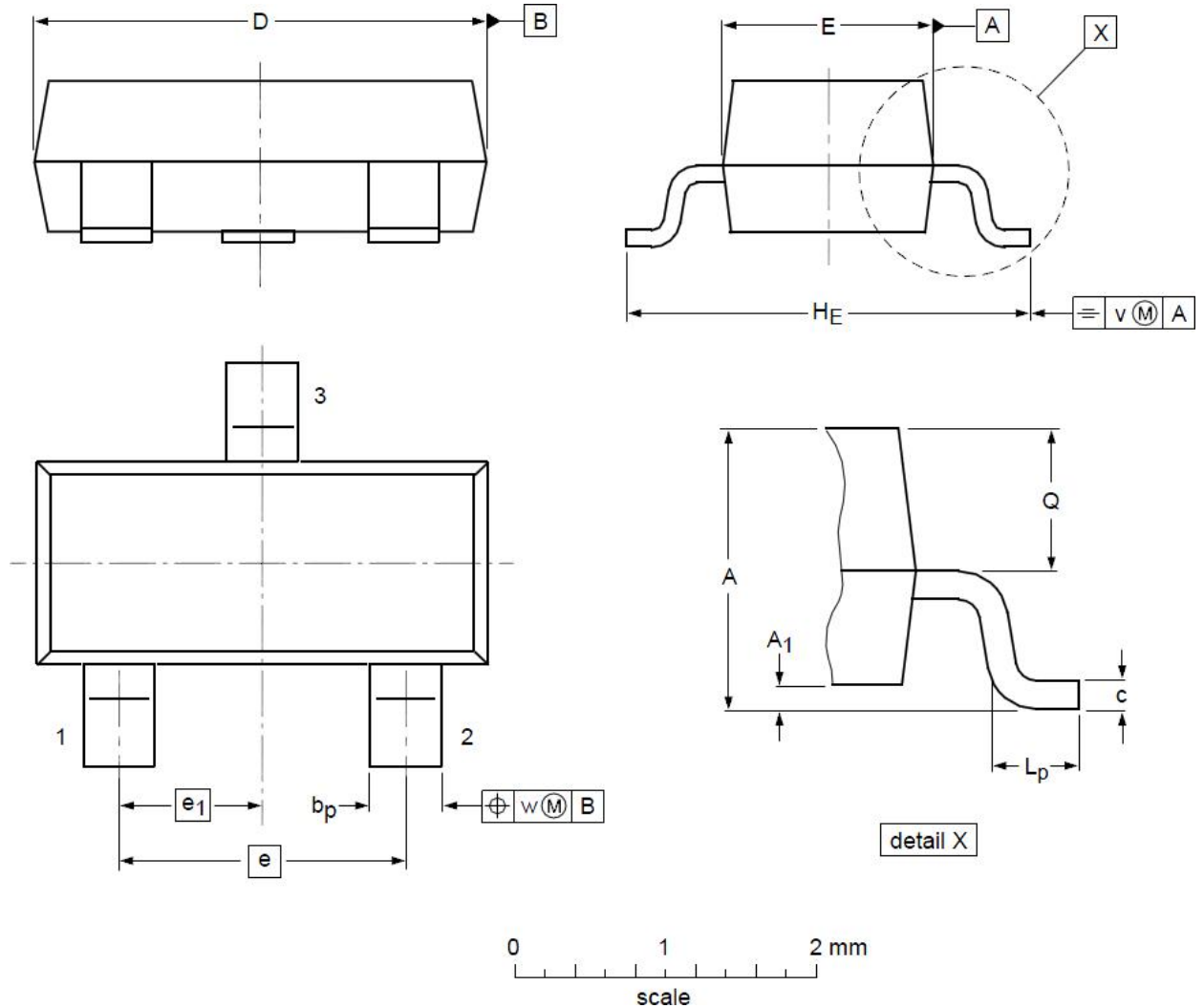


Figure9. Normalized Maximum Transient Thermal Impedance


**Resistive Switching Test Circuit & Waveforms**

**Diode Recovery Test Circuit & Waveforms**

**Gate Charge Test Circuit & Waveform**

**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**

### Package Mechanical Data-SOT-23



#### DIMENSIONS ( unit : mm )

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
<b>A</b>	0.90	1.01	1.15	<b>A<sub>1</sub></b>	0.01	0.05	0.10
<b>b<sub>p</sub></b>	0.30	0.42	0.50	<b>c</b>	0.08	0.13	0.15
<b>D</b>	2.80	2.92	3.00	<b>E</b>	1.20	1.33	1.40
<b>e</b>	--	1.90	--	<b>e<sub>1</sub></b>	--	0.95	--
<b>H<sub>E</sub></b>	2.25	2.40	2.55	<b>L<sub>p</sub></b>	0.30	0.42	0.50
<b>Q</b>	0.45	0.49	0.55	<b>v</b>	--	0.20	--
<b>w</b>	--	0.10	--				


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